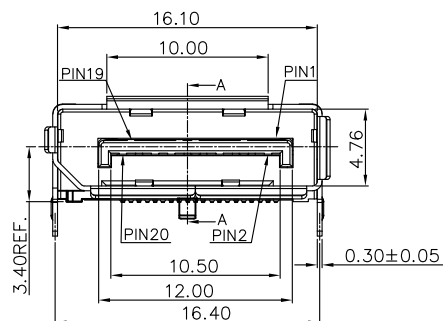
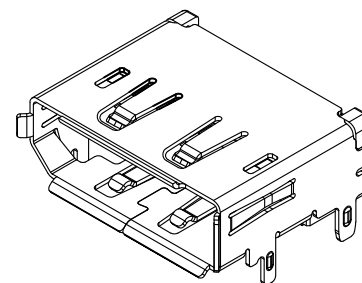
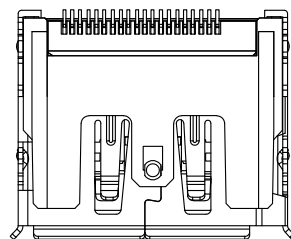
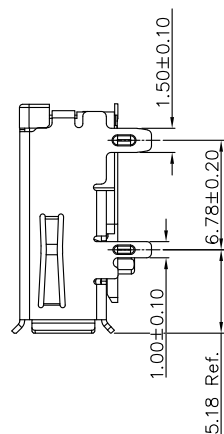
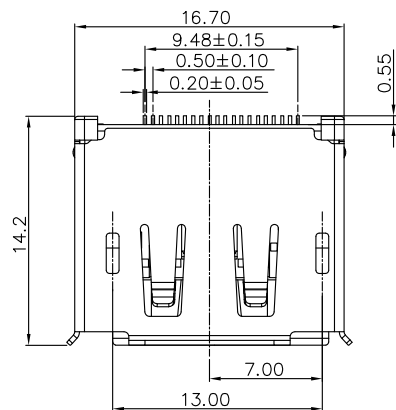


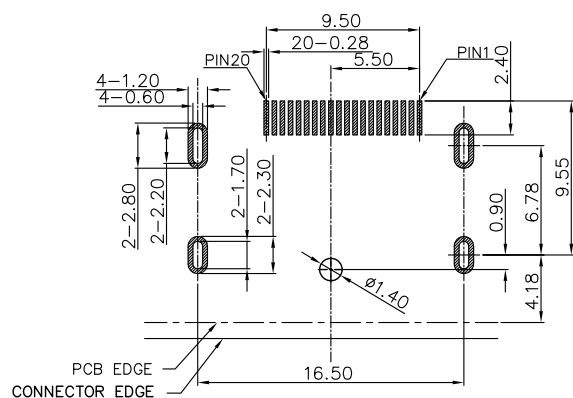
SECTION A-A

MATERIALS

1. HOUSING : LCP (UL94V-0), BLACK.
2. TERMINAL : COPPER ALLOY,
GOLD FLASH ON CONTACT AREA.
TIN PLATED ON SOLDER TAIL,
UNDER NICKEL PLATED.
3. SHELL : STAINLESS STEEL, NICKEL PLATED.

SPECIFICATION

1. CURRENT RATING : 0.5A. MAX.
2. DIELECTRIC WITHSTANDING VOLTAGE :
500V AC R.M.S. FOR ONE MINUTE.
3. INSULATION RESISTANCE : 100MΩ MIN. AT 500V DC.
4. CONTACT RESISTANCE : 30mΩ MAX.
5. OPERATING TEMPERATURE : -25°C TO +85°C.
6. DURABILITY : 10000 CYCLES.
7. MATING FORCE : 4.5kgf MAX.
8. UNMATING FORCE : 1.0kgf MIN.

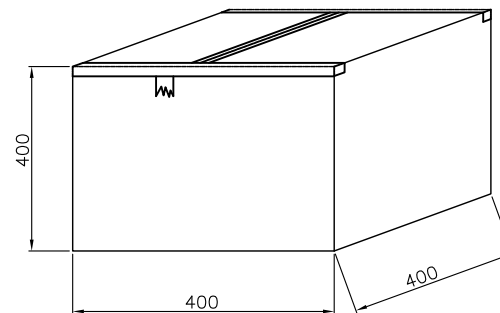
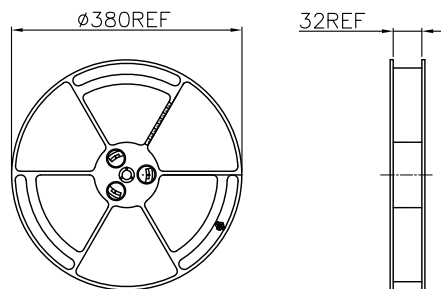
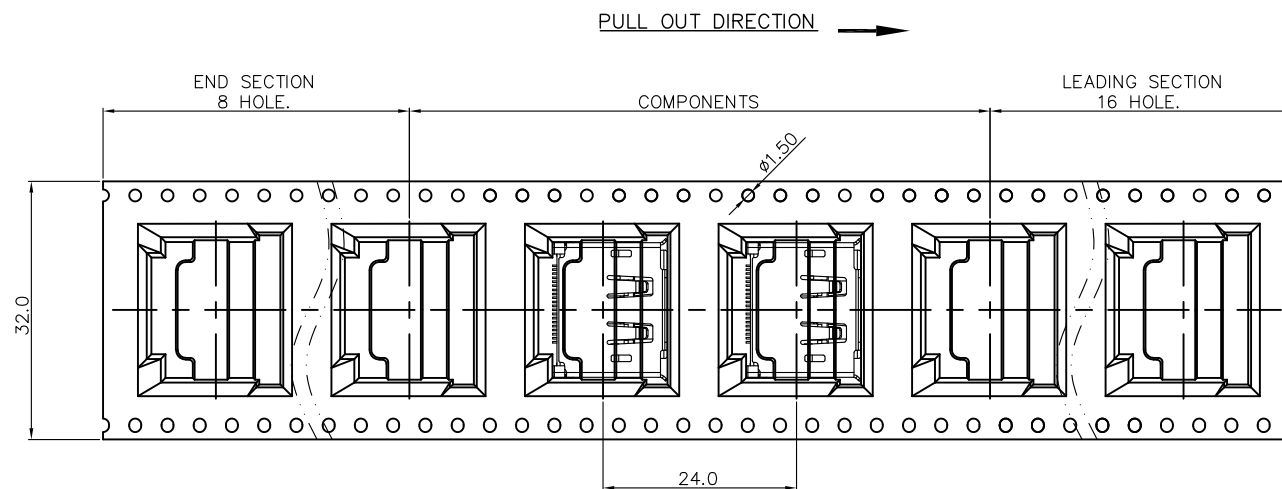


RECOMMEND PCB LAYOUT
TOLERANCE: ±0.05



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TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5*	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: DP 2.1 SMT 有弹带卡点	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYCW60-DP20-142B	MOLD NO.
 UNIT: mm [inch] SCALE: 1:1 SIZE: A4	APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO: HYC-2606161636	SHEET NO. 1 OF 1



包装数量:

1. 350PCS / 盘
2. 10 盘 /箱(3500PCS /箱)

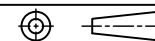


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TOLERANCE:

X.X ±0.30
X.XX ±0.25
X.XXX ±0.15

X.* ±2* X.X* ±0.5*



UNIT: mm [inch]

SCALE: 1:1 SIZE: A4

DRAWN BY:

陈一鸣

DATE:

2014-02-23

PART NAME:

包装图

CHECKED BY:

马跃

DATE:

2014-02-23

PART NO.

MOLD NO.

APPROVED BY:

邱敏

DATE:

2014-02-23

DRAW NO:

SHEET NO.

1 OF 1